Code: ECMC2T1

## I M. Tech - II Semester - Regular Examinations - December 2013

## SOLID STATE MICROWAVE DEVICES & CIRCUITS (MICROWAVE & COMMUNICATION ENGINEERING)

Duration: 3 hours Marks: 5x14=70

Answer any FIVE questions. All questions carry equal marks

- 1. a) Give the construction details of Magnetron and derive its expression for frequency of oscillations. 8 M
  - b) Draw the circuit diagram of Two Cavity Klystron and explain its principal of operation.

    3 M
  - c) What is the bunching effect?
- 2. a) Explain principle of operation of TRAPATT with neat sketch. 7 M
  - b) Explain the working of PIN diode and draw its equivalent circuit.

    7 M
- 3. a) Why are IMPATT diode noisy?
  - b) Derive the IMPATT diode impedance, power conversion and efficiency.

4. a) Explain principle of operation and V-I characteristics of	
HBT's with circuit diagram.	8 M
b) Give the RWH theory.	6 M
5. a) Draw the schematic of a JFET and explain principle of	f
operation.	8 M
b) Draw the V-I characteristics of JFET.	3 M
c) What are the applications of JFET.	3 M
6. a) Explain principle of operation of MESFET with neat sketch.	6 M
b) Distinguish between MESFET and MOSFET.	4 M
c) Derive the maximum operating frequency of MOSFET.4 M	
7. a) Derive the expression for power gain, noise and stabil	lity of
amplifiers.	9 M
b) Explain about non-linear behavior of amplifier.	5 M
8. a) What are the types of transistor oscillator configuration explain any one configuration and derive the express	
for frequency of oscillations.	10 M
b) What is the concept of negative resistance?	4 M